Desorption and Sputtering on Solid Surfaces by Low-energy Multicharged Ions

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1. Background

- Sputtering and desorption on solid surfaces induced by slow multicharged ions have been attracting attention because of
- high sputtering yield and its strong charge state (or potential energy) dependence as well as weak kinetic energy dependence, and following
- nanostructure formation in every ion impact.

1-1. Sputtering and desorption

	OES	SIMS					Quartz Micro- balance
Species	H*	H+		O⁺ Ti⁺	Si ⁺	$(UO_x)_y^+$	Total
Substrate	Si(100)/H ₂	Si(100) 1×1 H ¹⁾ Si(111) 1×1 H ²⁾	SAM(MUD A and DDT)	TiO ₂ (100)	Si(111) 1×1 H ²⁾	U	$\begin{array}{l} LiF^{3)}\\ NaCl^{4)}\\ SiO_{2^{3)}} \end{array}$
Projectiles	Xe ^{q+} 6 ≤ q ≤ 22	Xe^{q+} $4 \le q \le 12$ I^{q+} $17 \le q \le 53$	Ar ^{q+} 4 ≤ q ≤ 10	l ^{q+} 25 ≤ q ≤ 51	l ^{q+} 17 ≤ q ≤ 53	Au ^{$q+$} 36 $\leq q \leq$ 69 Xe ^{$q+$} 17 $\leq q \leq$ 52	
Yield	~ $q^{2.8 \pm 0.3}$	$\sim q^5$ $\sim q^{3.4}$	$\sim q^5$		~ q ^{1.4}		
Authors	Deiwiks (2006)	1) Kuroki (2003) 2) Tona (2006)	Flores (2009)	Tona (2008)	Tona (2006)		3) Sporn (1997) 4) Varga (1997)

1-2. Nanostructure formation LIF TiO₂ HOPG Mica KBr Si CaF₂ Blister¹⁾ or Hillock²⁻⁵⁾ Pit⁸⁾ Caldera¹⁰⁾ Hillock⁷⁾ Crater⁹⁾ Hilock²⁾ shape $d \propto q$ E_P-dep. $V \propto E_P$ $V \propto E_P$ $V \propto E_P$ of size $h \propto q$ (E_P>14 keV) 3) Minniti (2001) 1) Shneider 4) Hayderer 7) El-Said (1993) (2001) 8) Heller 9) Tona 10) Tona Authors (2007) 2) Parks (2008) (2007) (2008) 5) Nakamura (1998) (2005) 6) Tona (2007)

1-3. Nanostructuring and Sputtering							
	Contribution of Potential Energy <i>E</i> P	Contribution of Kinetic Energy <i>E</i> _K					
Nanostructuring	Volume ~ E_P (Diameter ~ q , Height ~ q) Coulomb Explosion	Independence or weak dependence of <i>E</i> _K Coulomb Explosion Inelastic Thermal Spike					
Sputtering	Hydrogen Atoms/Molecules/Ions Yield ~ q^n (3 ≤ n ≤ 5) Pair-wise Potential Sputtering Heavy Atoms/Molecules/Ions Yield ~ q^m (1 ≤ m ≤ 2) Defect Mediated Potential Sputtering	Hydrogen Atoms/Molecules/Ions Negative dependence of <i>E</i> _K Heavy Atoms/Molecules/Ions Weak dependence of <i>E</i> _K Kinetically Assisted Potential Sputtering					



3. Objective

 To measure velocity or kinetic energy of particles participating in the collisions in order to investigate the kinematics of sputtering, desorption, and nanostructuring induced by slow multicharged ion collisions with solid surfaces.



4. Experimental Methods

4.1 TOF-SIMS studies

4.1.1 3D-momentum spectroscopy of secondary ions

4.1.2 Simultaneous TOF-SIMS/LEIS analysis

4.2 OES study



































There was no significant change of $\langle v_{\parallel} \rangle$ among different charge states as well as between metal and insulator surfaces.

6-3-2. $< v > of Ti^*$ (in progress)



 $Ti^* (3d^24s4p x^3G)$ $\tau = 10.6 \text{ ns}$ $<v > = (7+3) \times 10^4 \text{ m/s}$

Measurement of charge-state dependence of $\langle v \rangle$ is now on going.

Summary

- TOF-SIMS coincidence measurements on scattered atoms/ions and secondary ions, and OES measurements of sputtered neutral atoms were conducted to investigate the dynamics of desorption and sputtering due to electron capture by slow multicharged ions.
- Anisotropic distributions in the proton emissions for glancing-incidence collisions were observed.
- It was found in the simultaneous TOF-SIMS and LEIS measurement that potential sputtering of protons induced by electron capture is followed by elastic scattering between projectile ions and surface atoms in the first and second layers.
- The mean velocity, parallel to the surface, of sputtered substrate atoms were almost independent on charge state of incident ions.
- The measurements of mean velocity, perpendicular to the surface, of sputtered substrate atoms are now in progress.

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